

STRUCTURE Silicon Monolithic Integrated Circuit

NAME OF PRODUCT DC-AC Inverter Control IC

TYPE **BD9895FV**

- FUNCTION
- 2ch control with Half-Bridge
  - Lamp current and voltage sense feed back control
  - Sequencing easily achieved with Soft Start Control
  - Circuit protection with Timer Latch
  - Under Voltage Lock Out
  - Over Voltage Protection
  - Mode-selectable the operating or stand-by mode by stand-by pin
  - BURST mode controlled by PWM and DC input
  - Output linear Controllable Analog dimming by external DC voltage
  - Synchronous operating the other several BD9895FV IC' s

○Absolute Maximum Ratings (Ta = 25°C)

Parameter	Symbol	Limits	Unit
Supply Voltage	Vcc	15	V
Operating Temperature Range	Topr	-40~+90	°C
Storage Temperature Range	Tstg	-55~+150	°C
Power Dissipation	Pd	1062*	mW
Maximum Junction Temperature	Tjmax	+150	°C

\*Pd derated at 8.5mW/°C for temperature above Ta = 25°C (When mounted on a PCB 70.0mm×70.0mm×1.6mm)

○Recommended operating condition

Parameter	Symbol	Limits	Unit
Supply voltage	Vcc	6.0~14.0	V
Output oscillation frequency	f <sub>out</sub>	25~90	kHz
BCT oscillation frequency	f <sub>BCT</sub>	0.05~1.00	kHz

Status of this document

The Japanese version of this document is the official specification.

Please use the translation version of this document as a reference to expedite understanding of the official version.

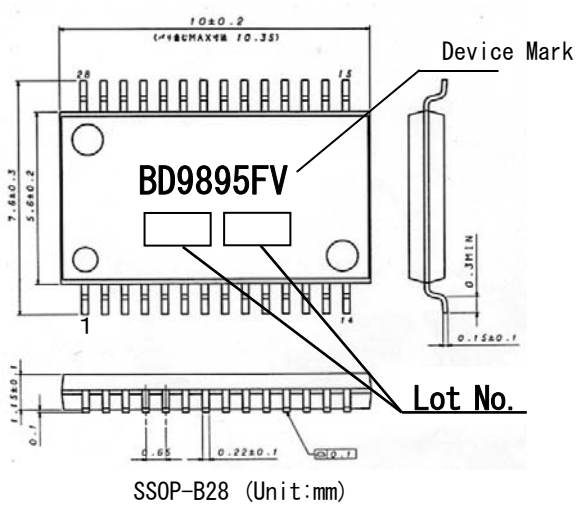
If these are any uncertainty in translation version of this document, official version takes priority.

○Electric Characteristics (Ta=25°C, VCC=7V)

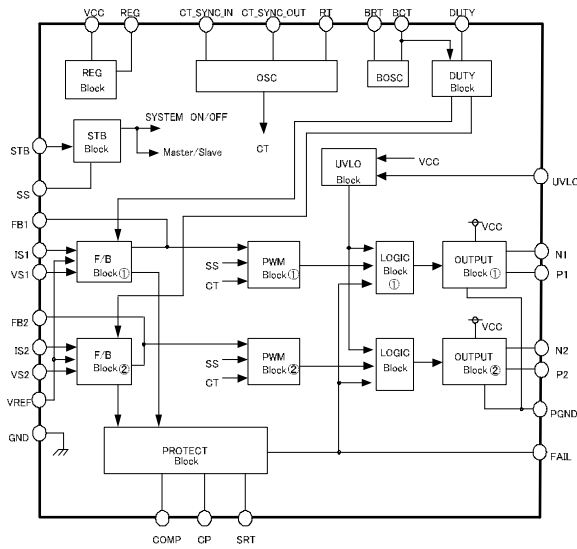
Parameter	Symbol	Limits			Unit	Conditions
		MIN.	TYP.	MAX.		
((WHOLE DEVICE))						
Operating current	Icc1	—	—	17.0	mA	CT_SYNC_IN=Low
Stand-by current	Icc2	—	—	10	μA	CT_SYNC_IN=OPEN
((OVER VOLTAGE DETECT))						
FB over voltage detect voltage	Vovf	2.20	2.40	2.60	V	
((STAND BY CONTROL))						
Stand-by voltage L	VstL	-0.3	—	0.8	V	
Input voltage range of Slave setting	Vsth1	1.8	—	2.25	V	
Input voltage range of Master setting	Vsth2	2.55	—	VCC	V	
((TIMER LATCH))						
Timer Latch voltage	Vcp	1.9	2.0	2.1	V	
Timer Latch current	Icp	0.5	1.0	1.5	μA	
((BURST MODE))						
BOSC Max voltage	VburH	1.94	2.0	2.06	V	fBCT=0.3kHz
BOSC Min Voltage	VburL	0.4	0.5	0.6	V	fBCT=0.3kHz
BOSC constant current	IBCT	1.35/BRT	1.5/BRT	1.65/BRT	A	
BOSC frequency	fBCT	292.5	300	307.5	Hz	BRT=36kΩ BCT=0.048μF
((OSC BLOCK))						
MAX DUTY	MAXDUTY	44.0	48.0	49.5	%	fout=60kHz
Soft start current	Iss	1.0	2.0	3.0	μA	
IS COMP detect Voltage	Visc	0.45	0.50	0.55	V	
SS COMP detect voltage	Vssc	2.0	2.2	2.4	V	
SRT ON resistance	RSRT	—	200	400	Ω	
((UVLO BLOCK))						
Detect voltage (VCC_UVLO)	Vcc_vuvlo	5.100	5.300	5.500	V	
Hysteresis width (UVLO)	ΔVcc_vuvlo	0.150	0.200	0.250	V	
Operating voltage (VCC_UVLO)	Vuvlo	2.260	2.340	2.420	V	
Hysteresis width (VCC_UVLO)	ΔVuvlo	0.075	0.100	0.125	V	
((REG BLOCK))						
REG output voltage	VREG	3.038	3.100	3.162	V	
REG source current	IREG	5.0	—	—	mA	
((FEED BACK BLOCK))						
IS threshold voltage ①	Vis①	1.225	1.250	1.275	V	VREF pin: OPEN, REG is shorted
IS threshold voltage ②	Vis②	—	VREF IN	VIS①	V	VREF pin is supplied
VS threshold voltage	Vvs	1.220	1.250	1.280	V	
IS source current 1	Iis1	—	—	1.5	μA	DUTY=2.2V
IS source current 2	Iis2	13.0	20.0	27.0	μA	DUTY=0V, IS=0.5V
VS source current	Ivs	—	—	1.0	μA	
VREF input voltage range	VREF IN	0.6	—	1.6	V	Over 1.25V is not effective
((OUTPUT BLOCK))						
Pch output voltage H	VoutPH	VCC-0.3	VCC-0.1	—	V	
Nch output voltage H	VoutNH	VCC-0.3	VCC-0.1	—	V	
Pch output voltage L	VoutPL	—	0.1	0.3	V	
Nch output voltage L	VoutNL	—	0.1	0.3	V	
Pch output sink resistance	RsinkP	—	5	10	Ω	I <sub>sink</sub> = 10mA
Pch output source resistance	RsourceP	—	8	16	Ω	I <sub>source</sub> = 10mA
Nch output sink resistance	RsinkN	—	5	10	Ω	I <sub>sink</sub> = 10mA
Nch output source resistance	RsourceN	—	8	16	Ω	I <sub>source</sub> = 10mA
Drive output frequency	fOUT	57.9	60.0	62.1	KHz	RT=15kΩ
((COMP BLOCK))						
Overr voltage detect	VCOMP	2.4	2.5	2.6	V	
Hysteresis width (COMP)	ΔVCOMP	0.040	0.060	0.080	V	
((PROTECT CLOCK))						
FAIL-pin On resistor value	R_FAIL	—	200	400	Ω	
(( SYNCRO BLOCK))						
CT_SYNC_IN_High input Voltage Range	VCT_SYNC_IN_H	2.0	—	VCC*0.8	V	
CT_SYNC_IN_Low input Voltage Range	VCT_SYNC_IN_L	-0.3	—	1.5	V	
CT_SYNC_IN Pull-up resistor	RCT_SYNC_IN_pull_up	500	—	—	kΩ	
CT_SYNC_IN Self-oscillation voltage	VCT_SYNC_IN	VCC*0.9	—	VCC	V	
CT_SYNC_OUT sink resistor value	RCT_SYNC_OUT_sink	—	150	300	Ω	
CT_SYNC_OUT source resistor value	RCT_SYNC_OUT_source	—	370	740	Ω	
CT_SYNC_OUT_High output Voltage Range	VCT_SYNC_OUT_H	2.8	3.1	3.4	V	
CT_SYNC_OUT_Low output Voltage Range	VCT_SYNC_OUT_L	—	—	0.5	V	
SRT SYNC Exchange detect Voltage	Vsrctc	0.5	0.8	1.1	V	

(This product is not designed for normal operation with in a radio active environment.)

○Package Dimensions



○Block Diagram



○Pin Description

端子番号	端子名	機能
1	N1	FET driver for 1ch
2	P1	FET driver for 1ch
3	CP	External capacitor from CP to GND for Timer Latch
4	REG	Internal regulator output
5	FAIL	Protect clock output
6	VREF	Reference voltage
7	CT_SYNC_OUT	Output pin of CT synchronous signal
8	CT_SYNC_IN	Input pin of CT synchronous signal
9	RT	External resistor from SRT to RT for adjusting the triangle oscillator
10	SRT	External resistor from SRT to RT for adjusting the triangle oscillator
11	GND	GROUND
12	BCT	External capacitor from BCT to GND for adjusting the BURST triangle oscillator
13	BRT	External resistor from BRT to GND for adjusting the BURST triangle oscillator
14	DUTY	Control PWM mode and BURST mode
15	STB	Stand-by switch, Master/Slave selection
16	VS2	Error amplifier input④
17	IS2	Error amplifier input③
18	FB2	Error amplifier output②
19	VS1	Error amplifier input②
20	IS1	Error amplifier input①
21	FB1	Error amplifier output①
22	SS	External capacitor from SS to GND for Soft Start Control
23	COMP	Over voltage detector
24	VCC	Supply voltage input
25	UVLO	External Under Voltage Lock OUT
26	P2	FET driver for 2ch
27	N2	FET driver for 2ch
28	PGND	Ground for FET drivers

○NOTE FOR USE

1. When designing the external circuit, including adequate margins for variation between external devices and the IC. Use adequate margins for steady state and transient characteristics.
2. Recommended Operating Range  
The circuit functionality is guaranteed within of ambient temperature operation range as long as it is within recommended operating range. The standard electrical characteristic values cannot be guaranteed at other voltages in the operating ranges, however, the variation will be small.
3. Mounting Failures  
Mounting failures, such as misdirection or miscounts, may harm the device.
4. Electromagnetic Fields  
A strong electromagnetic field may cause the IC to malfunction.
5. The GND pin should be the location within  $\pm 0.3V$  compared with the PGND pin
6. BD9895FV has the short circuit protection with Thermal Shut Down System. When STB or Vcc pin re-supplied, They enables to cancel the latch. If It rise the temperature of the chip more than 170°C(TYP), It make the external FET OFF
7. Absolute maximum ratings are those values that, if exceeded, may cause the life of a device to become significantly shortened. Moreover, the exact failure mode caused by short or open is not defined. Physical countermeasures, such as a fuse, need to be considered when using a device beyond its maximum ratings.
8. About the external FET, the parasitic Capacitor may cause the gate voltage to change, when the drain voltage is switching. Make sure to leave adequate margin for this IC variation.
9. On operating Slow Start Control (SS is less than 2.2V), It does not operate Timer Latch.
10. By STB voltage, BD9895FV is changed to 3 states. Therefore, do not input STB pin voltage between one state and the other state (0.8~1.8, 2.25~2.55).

11. The pin connected a connector need to connect to the resistor for electrical surge destruction.
12. This IC is a monolithic IC which (as shown is Fig-1)has P<sup>+</sup> substrate and between the various pins. A P-N junction is formed from this P layer of each pin. For example, the relation between each potential is as follows,

○(When GND > PinB and GND > PinA, the P-N junction operates as a parasitic diode.)

○(When PinB > GND > PinA, the P-N junction operates as a parasitic transistor.)

Parasitic diodes can occur inevitably in the structure of the IC. The operation of parasitic diodes can result in mutual interference among circuits as well as operation faults and physical damage. Accordingly you must not use methods by which parasitic diodes operate, such as applying a voltage that is lower than the GND(P substrate)voltage to an input pin.

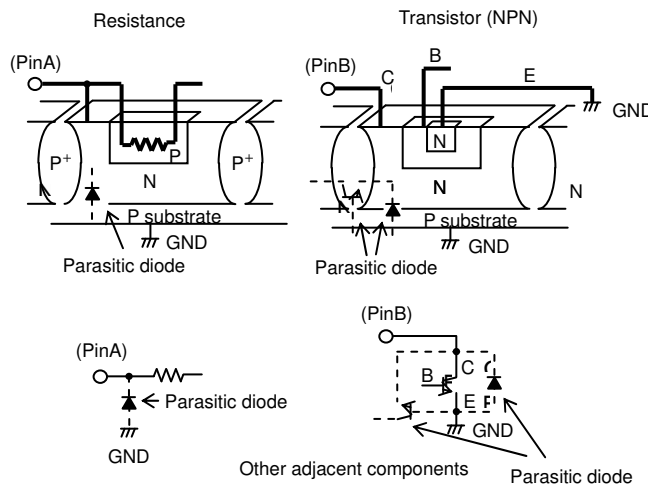


Fig-1 Simplified structure of a Bipolar IC

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